

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







TLE4247

Constant Current Relay Driver

Automotive Power





Table of Contents

Table of Contents

1	Overview	3
2	Block Diagram	1
3	Pin Configuration	5
3.1	Pin Assignment	
3.2	Pin Definitions and Functions	5
4	General Product Characteristics	3
4.1	Absolute Maximum Ratings 6	
4.2	Functional Range	7
4.3	Thermal Resistance	
5	Operation Modes 8	3
5.1	Description	3
5.2	Electrical Characteristics Tables	
6	Package Outlines	2
7	Revision History	3



Constant Current Relay Driver

TLE4247





1 Overview

Features

- · Reduces relay hold current to min. 40 mA
- Functional at low battery voltage.
- · Active freewheeling path using relay integrated freewheeling resistor.
- · Over temperature protection
- · Green Product (RoHScompliant)
- AEC-Q100 qualified



PG-DSO-8 (exposed pad)

Description

The TLE4247 is intended to drive relays with a constant current in order to reduce the coil current during relay hold phase. For relay activation, the IC pass element works as an activated switch for a limited period of time. After the activation time period has elapsed, the IC reduces the relay coil current to a lower constant value. Different operation modes allow adequate functionality also at very low or very high battery voltage.

The IC is suited to operate with relay coil inductance, freewheeling resistor, operating voltage and environment conditions as required in automotive applications. For details see operation range and electrical characteristics tables.

Туре	Package	Marking
TLE4247 EL40	PG-DSO-8 (exposed pad)	4247-40

Datasheet 3 Rev. 1.01, 2010-05-04

Block Diagram

2 Block Diagram

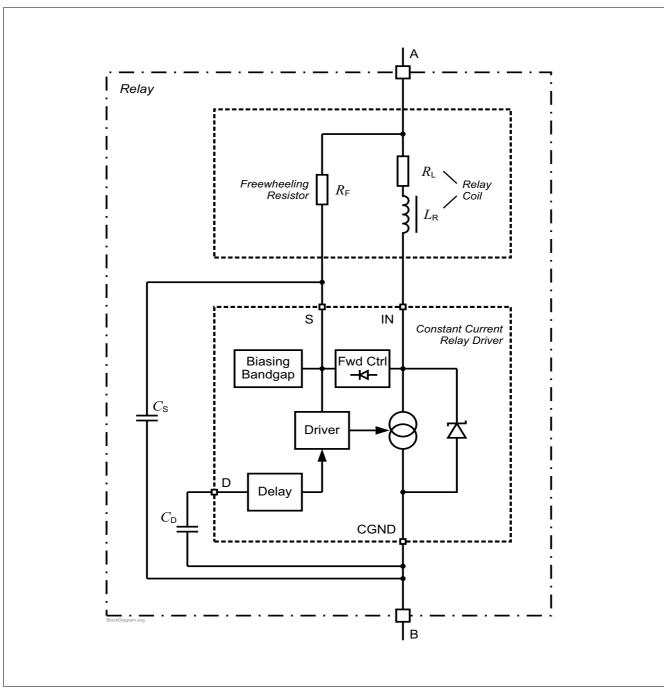


Figure 1 Block Diagram and Simplified Application Circuit



Pin Configuration

3 Pin Configuration

3.1 Pin Assignment

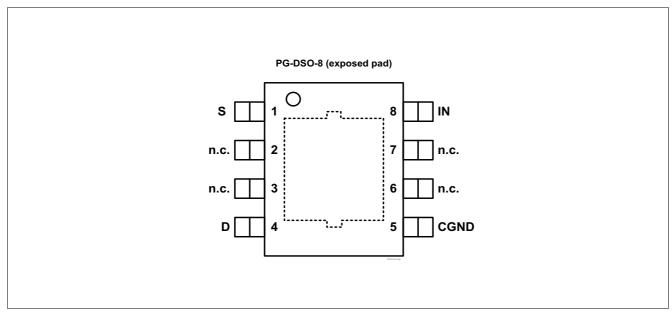


Figure 2 Pin Configuration

3.2 Pin Definitions and Functions

Pin	Symbol	Function
1	S	IC Supply; connect to relay coil freewheeling resistor according to Figure 1.
2, 3, 6, 7	n.c.	Not Connected; connection to heat sink area and CGND recommended.
4	D	Delay; for generating the activation time length, connect a ceramic capacitor between pin D and CGND.
5	CGND	Relay Coil Current Output and IC Ground;
8	IN	Relay Coil Current Input; connect to relay coil according to Figure 1.
Exposed Pad	_	Exposed Pad; interconnect with CGND and heat sink area on PCB.



General Product Characteristics

4 General Product Characteristics

4.1 Absolute Maximum Ratings

Absolute Maximum Ratings 1)

 $T_{\rm j}$ = -40 °C to +150 °C; all voltages with respect to CGND, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values		Unit	Conditions	
			Min.	Max.			
Pin S (I	C Supply)	+	+	+			
4.1.1	Voltage at pin S	V_{S}	-0.3	45	V	$V_{\rm S}$ > $V_{\rm IN}$ or $V_{\rm IN}$ open; $I_{\rm S}$ externally not limited	
4.1.2	Current into pin S	I_{S}	-400	_	mA	V _S < -0.3V	
Pin IN (Relay Coil Current Input)			<u> </u>			
4.1.3	Voltage at pin IN	V_{IN}	-0.3	30	V	$V_{\rm S}$ > $V_{\rm IN}$ or $V_{\rm S}$ open; $I_{\rm IN}$ externally not limited	
4.1.4	Current into pin IN	I_{IN}	-250	400	mA	_	
Pin D ([Delay)						
4.1.5	Voltage at pin D	V_{D}	-0.3	6.8	V		
Temper	ratures			<u> </u>			
4.1.6	Junction Temperature	T_{j}	-40	150	°C	_	
4.1.7	Storage Temperature	T_{stg}	-55	150	°C	-	
ESD Su	sceptibility	•		<u> </u>			
4.1.8	ESD Resistivity to CGND	$V_{\rm ESD,HBM}$	-4	4	kV	HBM ²⁾	
4.1.9	ESD Resistivity middle pins	$V_{\rm ESD,CDM}$		1.5	kV	CDM ³⁾	

¹⁾ Not subject to production test, specified by design.

Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Integrated protection functions are designed to prevent IC destruction under fault conditions described in the

data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

²⁾ ESD susceptibility, Human Body Model "HBM" according to EIA/JESD 22-A114B

³⁾ ESD susceptibility, Charged Device Model "CDM" according to EIA/JESD22-C101 or ESDA STM5.3.1



General Product Characteristics

4.2 Functional Range

Pos.	Parameter	Symbol	Lir	mit Values	Unit	Conditions
			Min.	Max.		
4.2.10	Supply Voltage	V_{S}	3	30	V	-
4.2.11	Input Capacitance	$C_{\mathbb{S}}$	70	_	nF	typ. 100nF/50V recommended for compensating line influences
4.2.12	Delay Capacitance	C_{D}	250	-	nF	typ. 470nF/6.3V recommended
4.2.13	Junction Temperature	$T_{\rm j}$	-40	150	°C	_
4.2.14	Relay Coil Inductance	L_{R}	_	1000	mH	_
4.2.15	Relay Coil Series Resistance	R_{L}	60	120	Ω	_
4.2.16	Relay Freewheeling Resistor	R_{F}	420	750	Ω	_

Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.

4.3 Thermal Resistance¹⁾

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Тур.	Max.		
PG-DSO-8 (exposed pad):							
4.3.1	Junction to Case Bottom	R_{thJC}	_	10	_	K/W	_
4.3.2	Junction to Ambient	R_{thJA}	_	70	_	K/W	1)

¹⁾ EIA/JESD 52_2, FR4, $80 \times 80 \times 1.5$ mm; 35μ Cu, 5μ Sn; 300 mm²

¹⁾ Not subject to production test, specified by design.



5 Operation Modes

5.1 Description

The TLE4247 provides two different operation modes: For relay activation, the IC pass element works as an activated switch with lowest dropout voltage $V_{\rm DR}$ (see Figure 3 a). After the activation time period $t_{\rm Actv}$ has elapsed, the IC switches to hold mode regulating the relay coil current to constant values (see Figure 3 b).

During commutation, the relay coil current flows from the IC input "IN" to "S" into the relay freewheeling resistor. A zener structure prevents the IC from overvoltage by limiting the input voltage transient to V_7 .

The relay activation time period $t_{\sf Actv}$ is generated by charging the external capacitor $C_{\sf D}$ at pin D with a constant current. This time period starts once the IC supply voltage exceeds $V_{\sf S,Start}$. In case the IC supply voltage $V_{\sf S}$ falls below the threshold $V_{\sf S,Hold-Actv}$, the IC changes to active mode allowing maximum relay current flow at low vehicle battery voltage.

At low supply voltage, the IC switches to "Low Voltage Mode" with lowest current consumption. As in activation mode, the IC is working as a switch with lowest dropout voltage.

In order to prevent the IC from excessive power dissipation at high supply voltage, the IC is working as a switch (High Voltage Mode). A transition to Hold Mode during this mode is not possible.

An overtemperature protection circuit prevents the IC from immediate destruction under fault conditions by reducing the output current. A thermal balance below 200 °C junction temperature will be established. Please note that a junction temperature above 150 °C is outside the maximum ratings and reduces the IC lifetime.

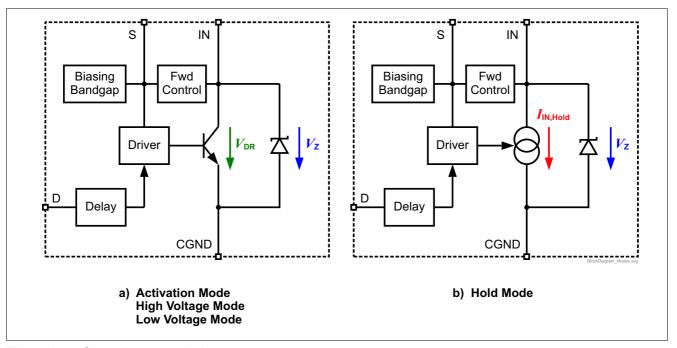


Figure 3 Operation as switch or current source



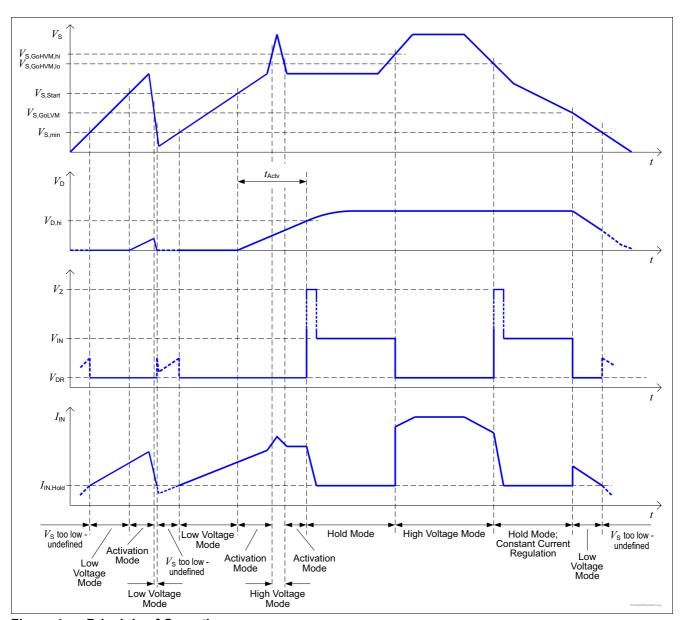


Figure 4 Principle of Operation

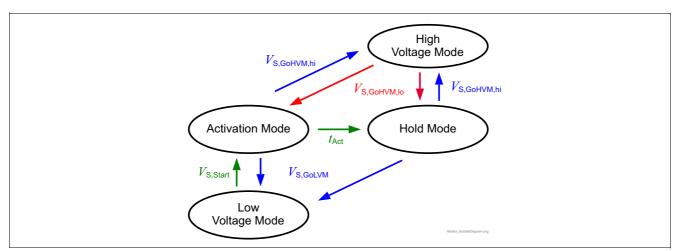


Figure 5 Conditions of transition between modes, definition of parameters



5.2 Electrical Characteristics Tables

 $T_{\rm j}$ = -40 °C to +150 °C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.			
Genera	ıl							
5.2.1	Freewheeling path drop voltage	V _{IN-S}		1	2	V	I_{IN-S} = 400 mA	
5.2.2	Input Zener Voltage	V_{Z}	30		45	V	$I_{\rm Z}$ = 50 mA	
5.2.3	Overtemperature Shutdown Threshold ¹⁾	$T_{j,sd}$	151	-	200	°C	$T_{\rm j}$ increasing due to power dissipation generated by the IC.	
Activat	sion Mode, $V_{\rm S} \geq V_{\rm S.Start}$, unless of	otherwise s	pecified					
5.2.4	Activation Mode Timing Start Supply Voltage Threshold	$V_{\mathrm{S,Start}}$	7	8	9	V	$V_{\rm S}$ increasing	
5.2.5	Activation Time Period	t_{Actv}	65	100	135	ms	$C_{\rm D}$ = 470 nF	
5.2.6	Dropout Voltage Activation Mode	$V_{DR,Actv}$	_	0.9	1.3	V	$I_{\rm IN}$ = 200 mA $V_{\rm S}$ = 9V	
5.2.7	Current consumption Activation Mode	$I_{S,Actv}$	-	0.85	1.5	mA	$I_{\rm IN}$ = 200 mA $V_{\rm S}$ = 9V	
	Activation wode						/ S - 3 V	
Hold M		nless other	wise spe	ecified				
	Activation Mode		wise spe	ecified 50	60	mA	-	
Hold M 5.2.8 5.2.9	ode, $V_{\mathrm{S,GoHVM}} \geq V_{\mathrm{S}} \geq V_{\mathrm{S,GoLVM}}$, u	nless other $I_{IN,Hold}$ $I_{S,Hold}$	1		60	mA mA	- V _S = 9V	
5.2.8	ode, $V_{\rm S,GoHVM} \geq V_{\rm S} \geq V_{\rm S,GoLVM}$, un Relay coil hold current Current consumption	$I_{IN,Hold}$	1	50			_	
5.2.8 5.2.9	ode, $V_{\rm S,GoHVM} \geq V_{\rm S} \geq V_{\rm S,GoLVM}$, un Relay coil hold current Current consumption	$I_{ m IN, Hold}$ $I_{ m S, Hold}$	40 - -	50 0.85 1	1.5	mA	- V _S = 9V	
5.2.8 5.2.9 Low V o	ode, $V_{\rm S,GoHVM} \geq V_{\rm S} \geq V_{\rm S,GoLVM}$, un Relay coil hold current Current consumption Hold Mode	$I_{ m IN, Hold}$ $I_{ m S, Hold}$	40 - -	50 0.85 1	1.5	mA	- V _S = 9V	
5.2.8 5.2.9	ode, $V_{\rm S,GoHVM} \geq V_{\rm S} \geq V_{\rm S,GoLVM}$, un Relay coil hold current Current consumption Hold Mode	$I_{\rm IN,Hold}$ $I_{\rm S,Hold}$ unless other	40 - - erwise s	50 0.85 1 specified	1.5	mA mA	$- V_{S} = 9V$ $V_{S} = 18V$	
5.2.8 5.2.9 Low Vo 5.2.10 5.2.11	ode, $V_{\rm S,GoHVM} \geq V_{\rm S} \geq V_{\rm S,GoLVM}$, under Relay coil hold current Current consumption Hold Mode oltage Mode, $V_{\rm S,Start} \geq V_{\rm S} \geq 3$ V, Go to Low Voltage Mode Threshold Go to Low Voltage Mode	$I_{\rm IN,Hold}$ $I_{\rm S,Hold}$ unless other $V_{\rm S,GoLVM}$	40 - - erwise s	50 0.85 1 specified 7	1.5	mA mA	$- V_{\rm S} = 9 {\rm V}$ $V_{\rm S} = 18 {\rm V}$ $V_{\rm S} \ {\rm decreasing}$ ${\rm Calculated \ value:}$ $V_{\rm S,GoLVM,hy} =$	
5.2.8 5.2.9 Low Vo 5.2.10 5.2.11	ode, $V_{\rm S,GoHVM} \geq V_{\rm S} \geq V_{\rm S,GoLVM}$, under Relay coil hold current Current consumption Hold Mode oltage Mode, $V_{\rm S,Start} \geq V_{\rm S} \geq 3$ V, Go to Low Voltage Mode Threshold Go to Low Voltage Mode Hysteresis	$I_{\rm IN,Hold}$ $I_{\rm S,Hold}$ unless other $V_{\rm S,GoLVM}$ $V_{\rm S,GoLVM,hy}$	40 - - erwise s	50 0.85 1 specified 7	1.5	mA mA	$V_{\rm S} = 9 \rm{V}$ $V_{\rm S} = 18 \rm{V}$	
5.2.8 5.2.9 Low Vo 5.2.10	ode, $V_{\text{S,GoHVM}} \geq V_{\text{S}} \geq V_{\text{S,GoLVM}}$, un Relay coil hold current Current consumption Hold Mode oltage Mode, $V_{\text{S,Start}} \geq V_{\text{S}} \geq 3 \text{ V}$, Go to Low Voltage Mode Threshold Go to Low Voltage Mode Hysteresis Dropout voltage Low Voltage Mode Dropout voltage	$I_{\rm IN,Hold}$ $I_{\rm S,Hold}$ unless other $V_{\rm S,GoLVM}$ $V_{\rm S,GoLVM,hy}$ $V_{\rm DR,LVM}$	40 - - erwise s	50 0.85 1 specified 7 1 0.85	1.5 1.8 8 -	mA mA V	$V_{\rm S} = 9 \rm V$ $V_{\rm S} = 18 \rm V$ $V_{\rm S} = 18$	



 $T_{\rm j}$ = -40 °C to +150 °C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Тур.	Max.		
High Vo	oltage Mode, $V_{S} \geq V_{S,GoHVM}$, ui	nless otherwi	ise spe	cified			
5.2.15	Go to High Voltage Mode Upper Threshold	$V_{\rm S,GoHVM,hi}$	19	_	21	V	$V_{ m S}$ increasing
5.2.16	Go to High Voltage Mode Lower Threshold	$V_{\rm S,GoHVM,lo}$	18	_	20	V	$V_{\rm S}$ decreasing
5.2.17	Go to High Voltage Mode Hysteresis	$V_{S,GoHVM,hy}$	0.7	1	-	V	Calculated value: $V_{\rm S,GoHVM,hy}$ = $V_{\rm S,GoHVM,hi}$ - $V_{\rm S,GoHVM,lo}$
5.2.18	Dropout Voltage High Voltage Mode	$V_{\mathrm{DR,HVM}}$	_	1.1	1.6	V	$I_{\rm IN}$ = 400 mA; $V_{\rm S}$ = 28V
5.2.19	Current Consumption High Voltage Mode	$I_{S,HVM}$	_	1	1.8	mA	$I_{\rm IN}$ = 400 mA; $V_{\rm S}$ = 28V

¹⁾ Specified by design, not subject to production test.



Package Outlines

6 Package Outlines

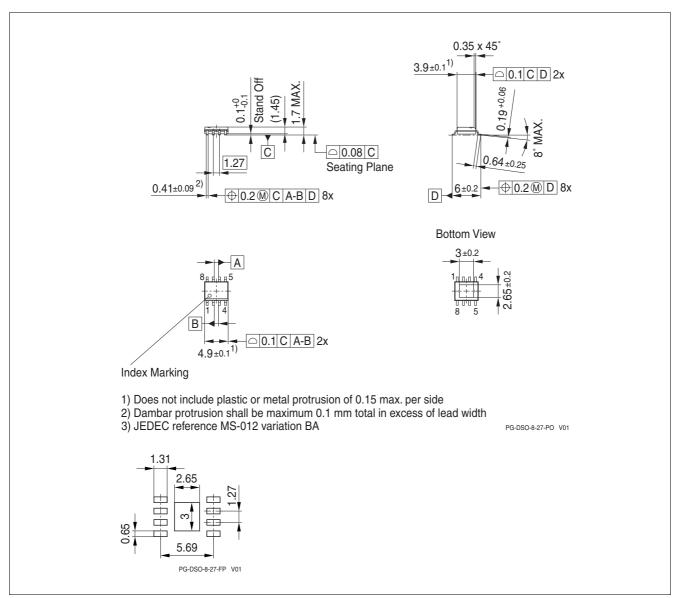


Figure 6 PG-DSO-8 (exposed pad) Outline and recommended footprint for reflow soldering

Green Product

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on Infineon packages, please visit our website: http://www.infineon.com/packages.

Dimensions in mm



Revision History

7 Revision History

Revision	Date	Changes
1.01	2010-05-04	Final Datasheet.

Edition 2010-05-04

Published by Infineon Technologies AG 81726 Munich, Germany © 2010 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.